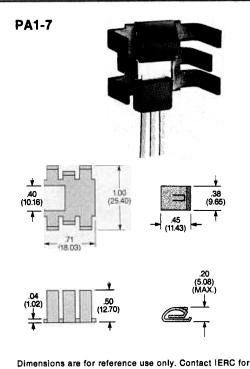
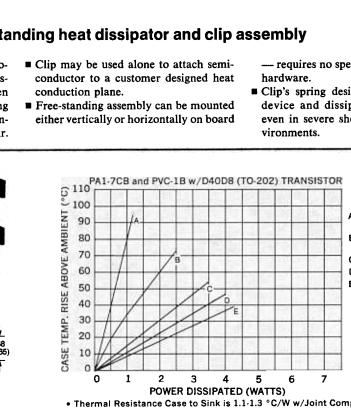


Free-standing heat dissipator and clip assembly

- Beryllium copper clip is designed to provide high clamping pressure, which assures low thermal resistance between dissipator and semiconductor, allowing a 150% power increase in natural convection to more than 400% in forced air.

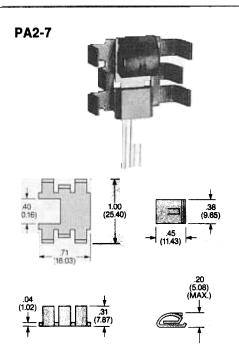
- requires no special tools or mounting
- Clip's spring design firmly attaches to device and dissipator, stays attached even in severe shock and vibration en-





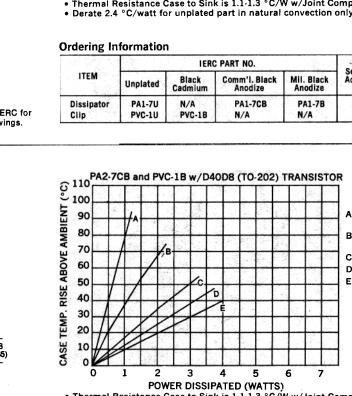
- DESCRIPTION OF CURVES
- A. N.C. Horiz. Device Only Freestanding.
- B. N.C. Horiz. & Vert. With Dissipator.
- C. 200 FPM w/Diss.
- D. 500 FPM w/Diss.
- E. 1000 FPM w/Diss.
- Thermal Resistance Case to Sink is 1.1-1.3 °C/W w/Joint Compound.
- Derate 2.4 °C/watt for unplated part in natural convection only.

ITEM		IERO	0	Max.		
	Unplated	Black Cadmium	Comm'l. Black Anodize	Mil. Black Anodize	Semiconductor Accommodated	Weight (Grams)
Dissipator Clip	PA1-7U PVC-1U	N/A PVC-1B	PA1-7CB N/A	PA1-7B N/A	TO-202 TO-202	2.0 0.7



dimensions with tolerances or standard part drawings

Dimensions are for reference use only. Contact IERC for dimensions with tolerances or standard part drawings.



DESCRIPTION OF CURVES

- A. N.C. Horiz. Device Only Freestanding.
- B. N.C. Horiz. & Vert. With Dissipator.
- C. 200 FPM w/Diss.
- D 500 FPM w/Diss.
- E. 1000 FPM w/Diss.
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 Derate 2.4 °C/watt for unplated part in natural convection only.

Ordering Information

ITEM		IER	Comisonductor	Max.		
	Unplated	Black Cadmium	Comm'l. Black Anodize	Mil. Black Anodize	Semiconductor Accommodated	Weight (Grams)
Dissipator Clip	PA2-7U PVC-1U	N/A PVC-1B	PA2-7CB N/A	PA2-7B N/A	T0-202 T0-202	1.5 0.7